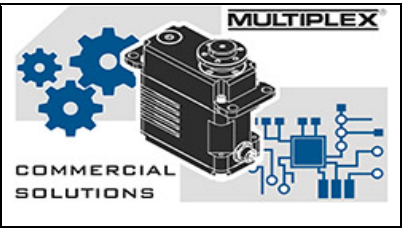




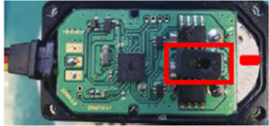
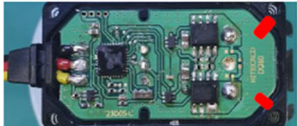


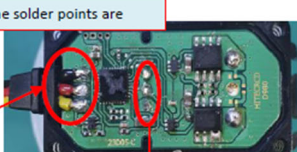
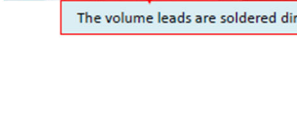
Product Change Notification



TITLE	MCU, PCB, connection method changes
DATE	2023.12.18
VALID FROM	1st quarter of 2024
AFFECTED PRODUCT(S)	D980TW
Please note: This change also affect all customized products based on affected products	

CHANGE

- No absorber needed after PCP shape change.
- Solder point & method changes – new layout without wires between the potentiometer and PCB.

	Before change	After change
No change in appearance and specification of the servo (Motor Change of this servo will be announced separately)		
Changing the shape of its PCB (Improved the support structure) // No Absorber after change		
Solder Point & Method Changes (3P Wires & Volume Leads)	 Wires between the volume and PCB will be removed 	 The solder points are  The volume leads are soldered directly to the

REMARKS

- Even if the change is applied, please note that the previous version of the stock would be shipped for a certain period.

TOPIC	MCU, PCB, connection method changes
EXPLANATION	The shape of the PCB / PCB design is changed (MCU). The connection method of potentiometer (volume) is changed from wire to header pin (direct soldering w/o wires). The solder points of connection wire are changed.
RISK ASSESSMENT	No negative effect to the function or quality of the device
BENEFIT	The durability of the support structure is increased. Improved workability.

	Name	Role	Date
Written by	M. Steinmetz	Tech. sales	2023-11-27
Reviewed by	Lauber	Technical dept.	2024-02-12
Approved	Lauber	Technical dept.	2024-02-12

THIS DOCUMENT IS VALID WITHOUT A SIGNATURE

